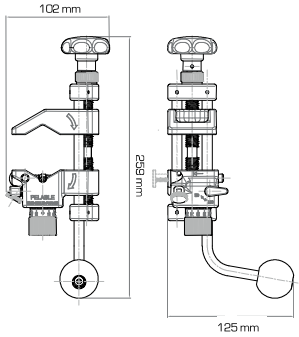
Ref: OUT SCP
Function:
Incising peelable semi-conductor

Capacity: 25 mm² to 630 mm²
Cutting depth: 1.1 mm.
End of semi-conductors with chamfer.
For all materials (Example: XLPE / EPR)
25 to 55 mm retractable stop
Weight: 1000 g

Replacement blades:
Ref: LAME OUT SCP CH



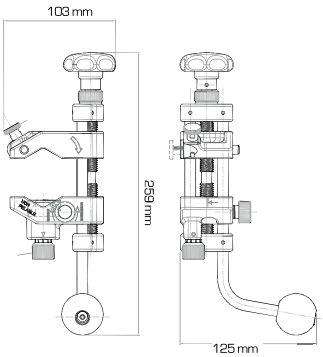
Use:

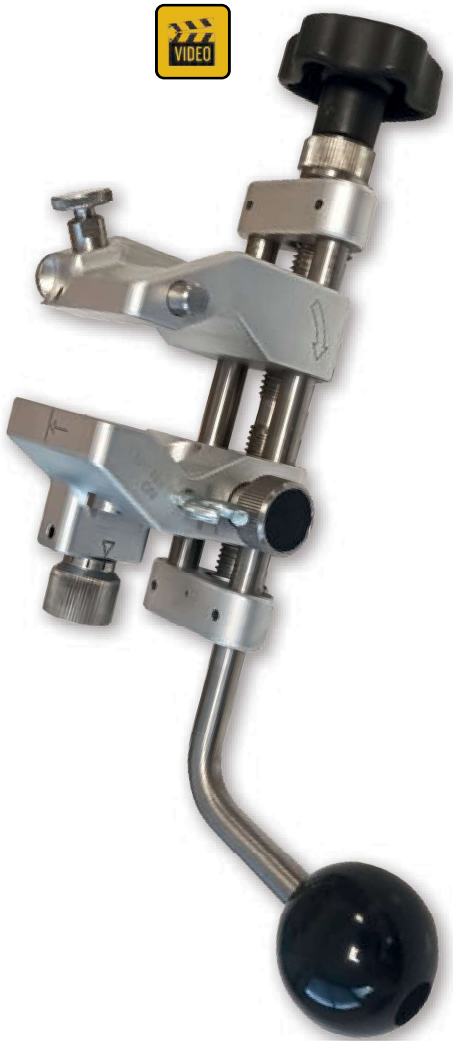
Incising and removing peelable semi-conductor

Ref: OUT SCNP
Function:
Machining bonded semi-conductor

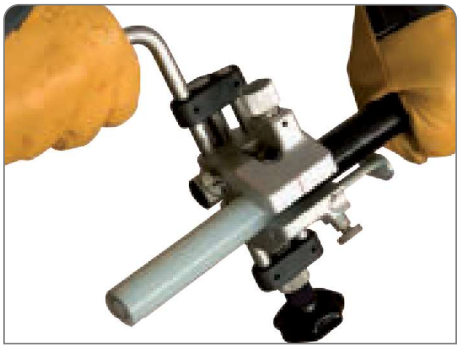
Capacity: 25 mm² to 630 mm²
End of semi-conductors with chamfer.
25 to 55 mm retractable stop
Weight: 1000 g

Replacement blades:
Ref: LAME OUT SCNP





Use:



Machining bonded semi-conductor
(End of semi-conductors with chamfer)